

Forte[™] Series provides:



Improved cost-of-ownership, equivalent or better accuracy and 20-50% higher productivity over the top selling Spectrum® ll



Reduced operator maintenance and intervention with standard integrated dual-valve service station, patented closed-loop process controls and nozzle cleaning rail



Blazing speed for point-to-point moves – matching our most advanced fluid dispensing system at 1.5 G



Maximized production floor efficiency — space saving footprint



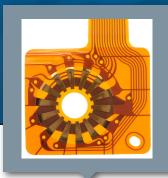
Higher throughput and accuracy with simultaneous dual-valve jetting and patented* real-time correction for X, Y, and Z-axis substrate skew



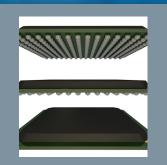
Flexible range of applications: Flex circuit assembly, PCBA, EMA, MEMS, Underfill, Precise Coating, and Encapsulation

*Nordson US Patents 9,707,584 and 10,150,131 and other patents pending.

Application Highlights









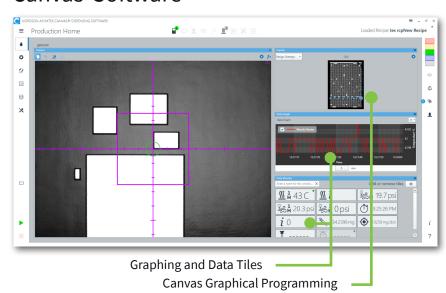
Flex Circuit Assembly

Encapsulation

Underfill

PCBA

Canvas[®] Software



A completely new software interface that simplifies programming tasks and provides powerful insight and control over your process

Graphical Programming – lets you scan a workpiece, develop your program on or offline, and simulate the dispensing results on a virtual canvas

Guided Wizards – provide easy step-by-step setup instructions

Quick-Reference Graphing and Data Tiles – allow you to control how system sensor and process data are displayed

Contact us.

Visit our website to find your local representative or regional office.

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